



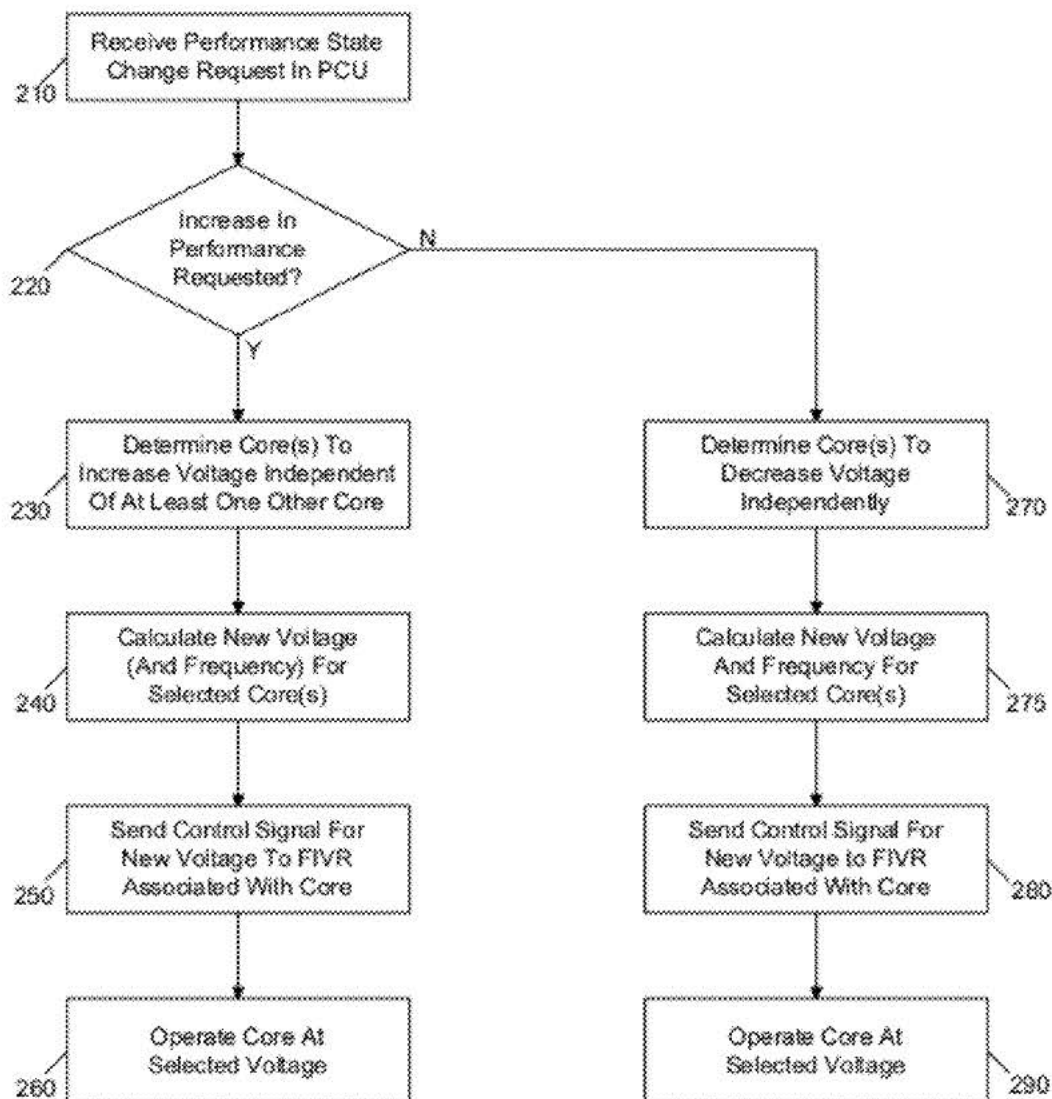
US 20120079290A1

(19) **United States**(12) **Patent Application Publication**
KUMAR et al.(10) **Pub. No.: US 2012/0079290 A1**(43) **Pub. Date: Mar. 29, 2012**(54) **PROVIDING PER CORE VOLTAGE AND
FREQUENCY CONTROL****Publication Classification**(51) **Int. Cl.**
G06F 1/26

(2006.01)

(52) **U.S. Cl.** **713/300**(57) **ABSTRACT**

In one embodiment, the present invention includes a processor having a plurality of cores and a control logic to control provision of a voltage/frequency to a first core of the plurality of cores independently of provision of a voltage/frequency to at least a second core of the plurality of cores. In some embodiments, the voltages may be provided from one or more internal voltage regulators of the processor. Other embodiments are described and claimed.

(76) **Inventors:** **PANKAJ KUMAR**, Chandler, AZ (US); **HANG NGUYEN**, Tempe, AZ (US); **CHRISTOPHER HOUGHTON**, Westborough, MA (US); **DAVID A. BIERMANN**, Portland, OR (US)(21) **Appl. No.: 12/889,121**(22) **Filed: Sep. 23, 2010****200**

100

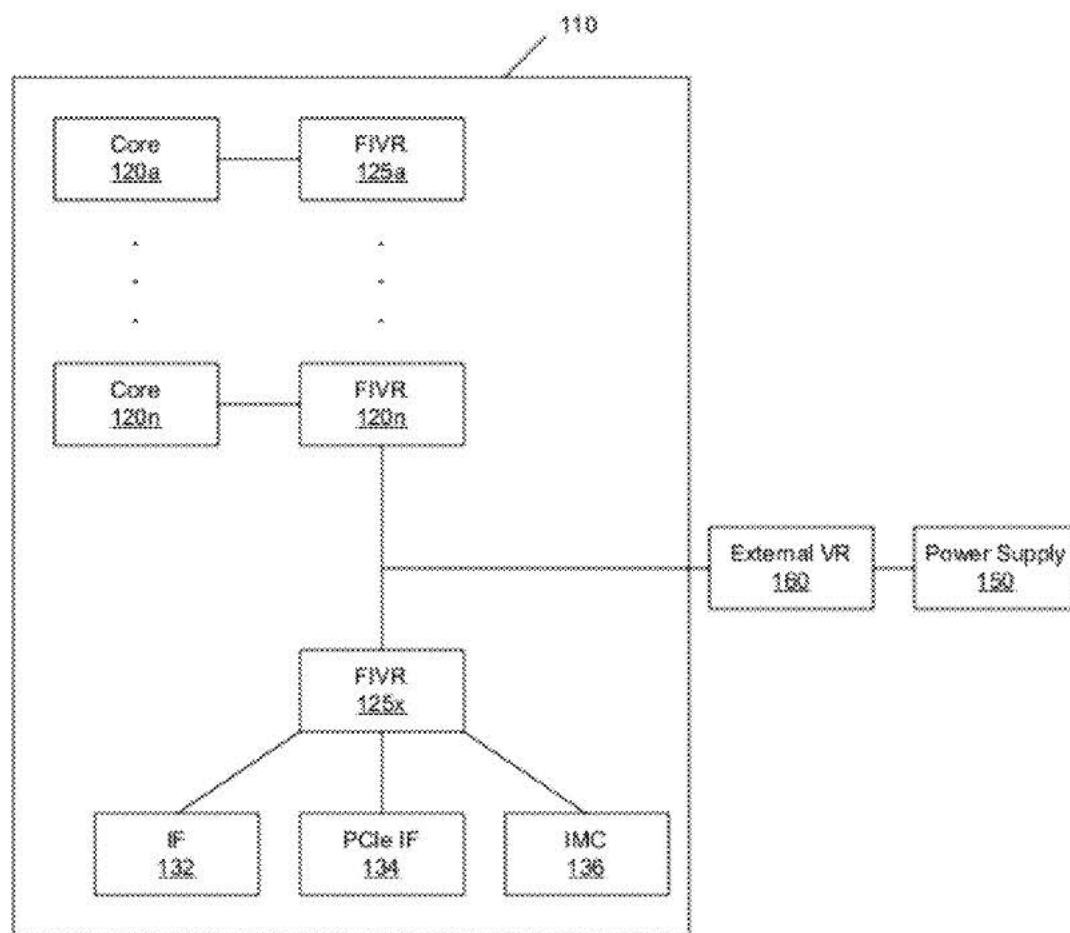


FIG. 1

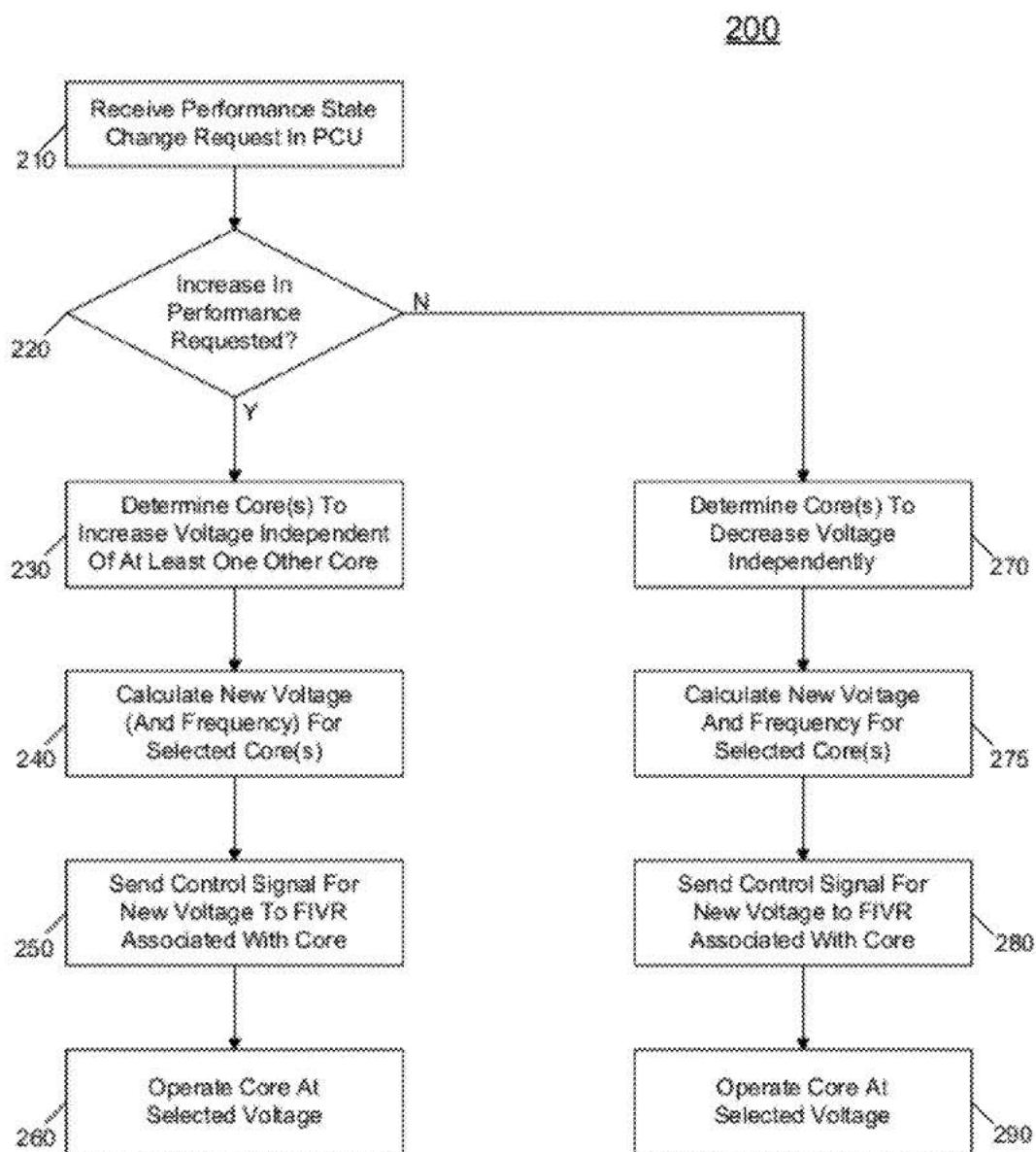


FIG. 2

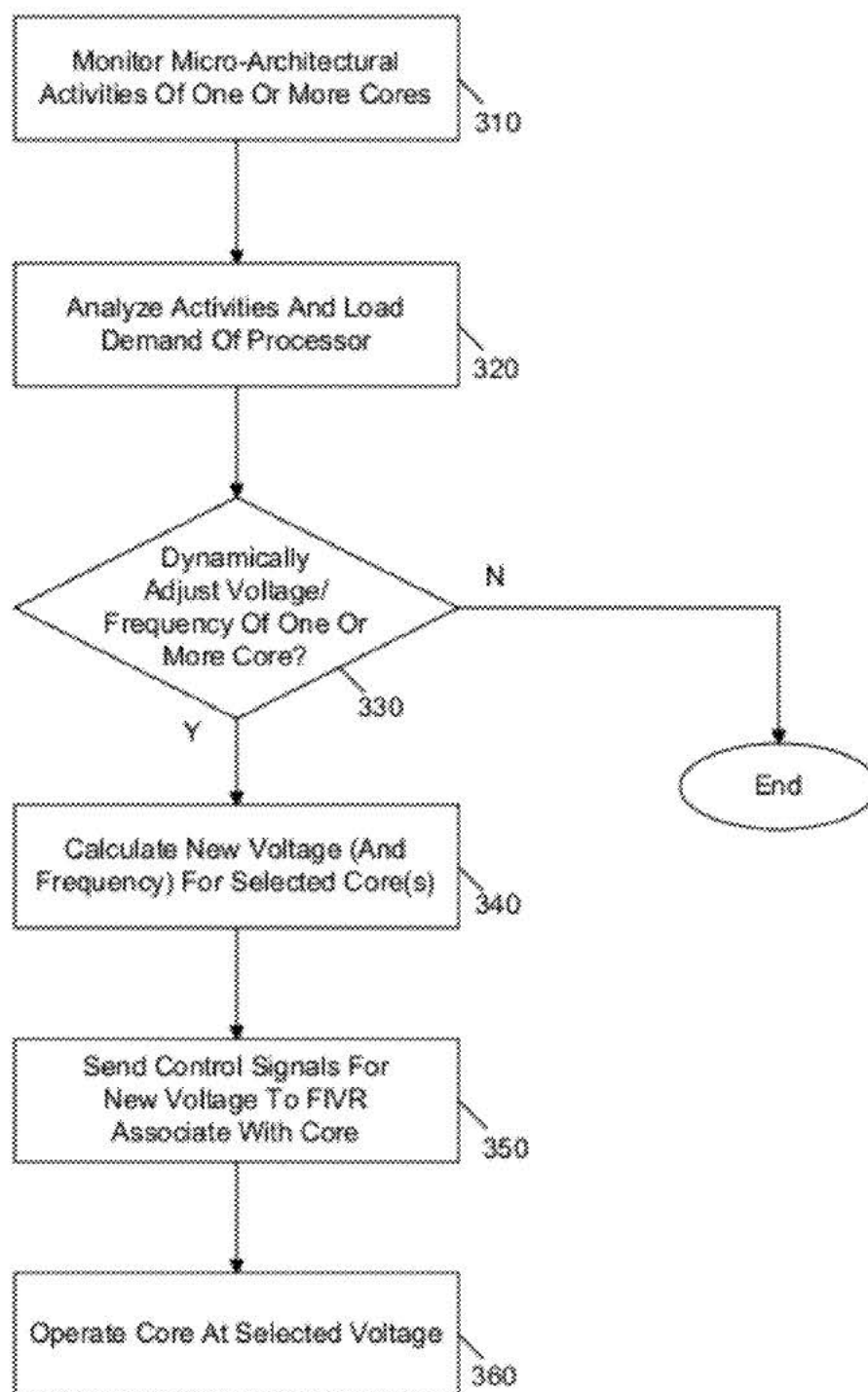
300

FIG. 3

400

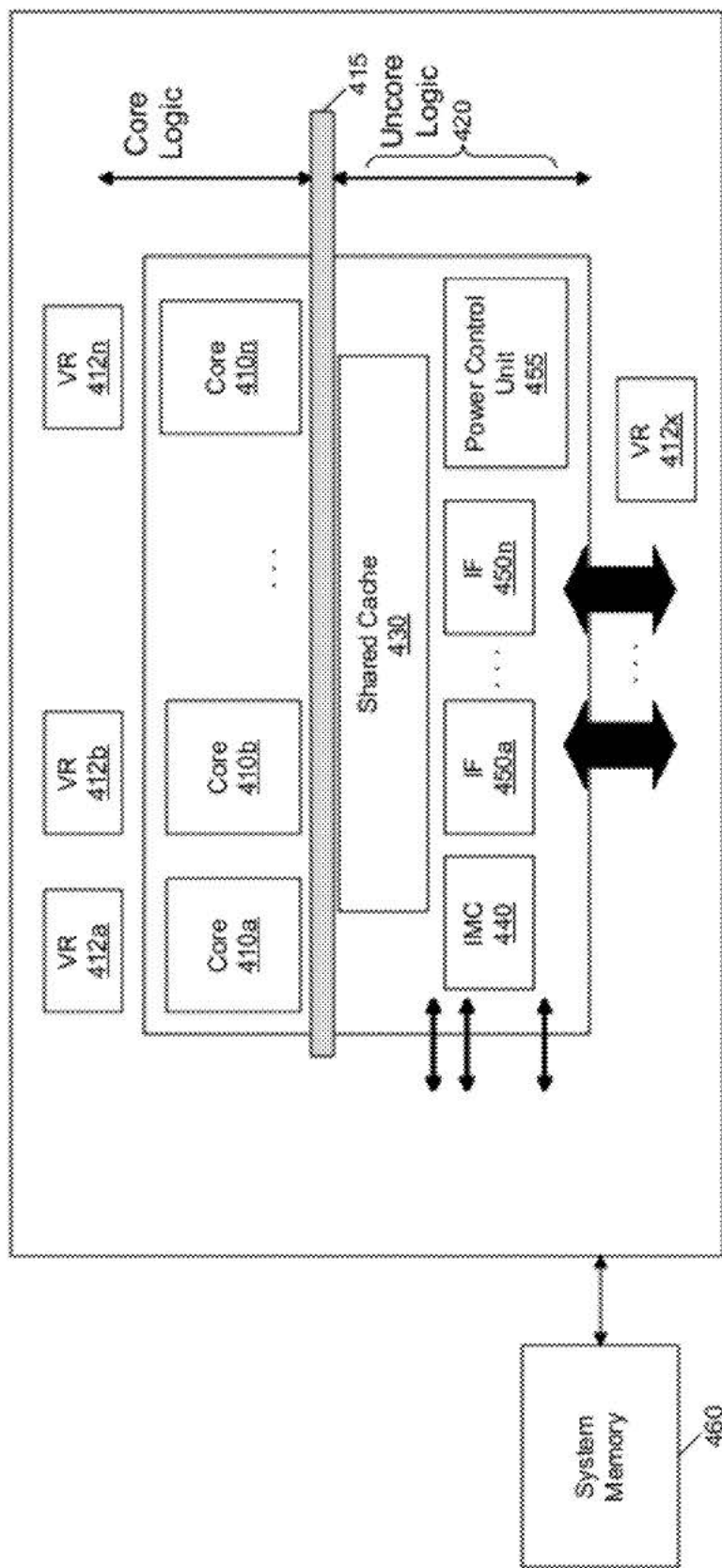


FIG. 4

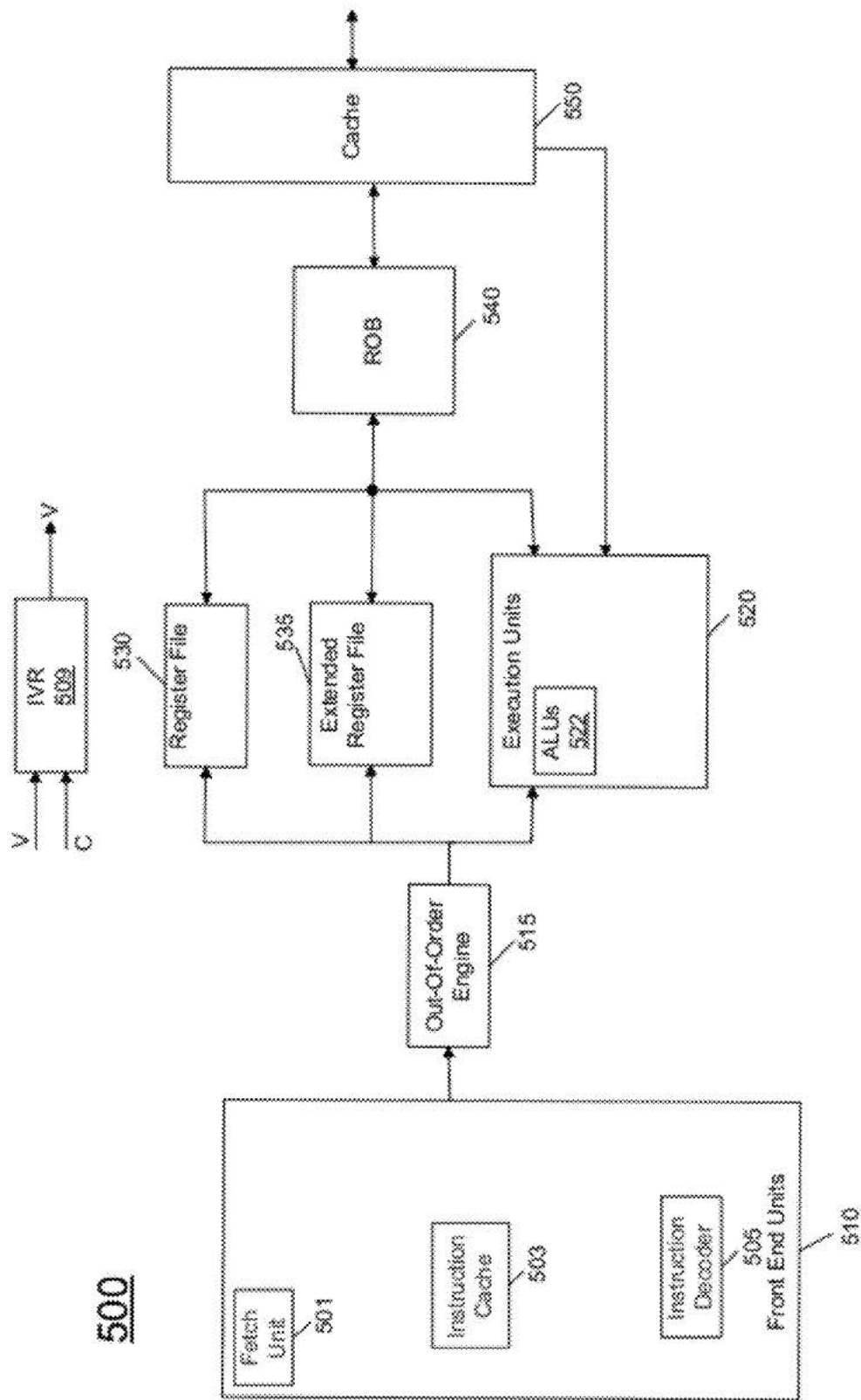


FIG. 5

PROVIDING PER CORE VOLTAGE AND FREQUENCY CONTROL

BACKGROUND

[0001] Power and thermal management issues are considerations in all segments of computer-based systems. While in the server domain, the cost of electricity drives the need for low power systems, in mobile systems battery life and thermal limitations make these issues relevant. Optimizing a system for maximum performance at minimum power consumption is usually done using the operating system (OS) or system software to control hardware elements. Most modern OS's use the Advanced Configuration and Power Interface (ACPI) standard, e.g., Rev. 3.0b, published Oct. 10, 2006, for optimizing the system in these areas. An ACPI implementation allows a processor core to be in different power-saving states (also termed low power or idle states), generally referred to as so-called C1 to Cn states. Similar package C-states exist for package-level power savings but are not OS-visible.

[0002] When a core is active, it runs at a so-called C0 state, and when the core is idle, it may be placed in a core low power state, a so-called core non-zero C-state. The core C1 state represents the low power state that has the least power savings but can be entered and exited almost immediately, while an extended deep-low power state (e.g., C3) represents a power state where the static power consumption is negligible, but the time to enter/exit this state and respond to activity (i.e., back to C0) is longer.

[0003] In addition to power-saving states, performance states or so-called P-states are also provided in ACPI. These performance states may allow control of performance-power levels while a core is in an active state (C0). In general, multiple P-states may be available, namely from P0-PN. In general, the ACPI P-state control algorithm is to optimize power consumption without impacting performance. The state corresponding to P0 may operate the core at a maximum voltage and frequency combination for the core, while each P-state, e.g., P1-PN, operates the core at different voltage and/or frequency combinations. In this way, a balance of performance and power consumption can occur when the processor is active based on utilization of the processor. While different P-states can be used during an active mode, there is no ability for independent P-states for different cores operating at different voltages and frequencies of a multi-core processor, and accordingly, optimal power savings cannot be attained while achieving a desired performance level, since at best all active cores may be able to operate at different frequencies but they all must share the same voltage.

BRIEF DESCRIPTION OF THE DRAWINGS

[0004] FIG. 1 is a block diagram of a system in accordance with one embodiment of the present invention.

[0005] FIG. 2 is a flow diagram of a method in accordance with one embodiment of the present invention.

[0006] FIG. 3 is a flow diagram of a method in accordance with another embodiment of the present invention.

[0007] FIG. 4 is a block diagram of a processor in accordance with an embodiment of the present invention.

[0008] FIG. 5 is a block diagram of a processor core in accordance with an embodiment of the present invention.

[0009] FIG. 6 is a block diagram of a system in accordance with an embodiment of the present invention.

DETAILED DESCRIPTION

[0010] In various embodiments, a processor having a multi-core architecture may provide for per core control of power-performance (P)-states, e.g., in accordance with an ACPI specification. In this way, better control over power consumption and performance can be realized. For example, in a multi-core processor only a few cores may be enabled to run at a higher core frequency in a thermally constrained environment, enabling execution of a desired workload while reducing power consumption and thus temperature.

[0011] Thus in various embodiments, each of multiple cores within a processor may be controlled to operate at a different voltage and/or frequency. In this way, asymmetric workloads may be executed on the multiple cores to provide for deterministic performance. While the scope of the present invention is not limited in this regard, in some embodiments the independent voltage/frequency control may be realized using a fully integrated voltage regulator (FIVR) implementation in which each core within a processor has its own voltage regulator. That is, a single semiconductor die that includes multiple cores may further include multiple independent voltage regulators, each associated with a given core. Furthermore, one or more additional voltage regulators may be provided for use with other components within a processor such as uncore logic, memory controller logic, power control unit, and so forth. Of course, in some embodiments a single voltage regulator may be associated with one or more cores and/or other components of a processor. In one embodiment, a dedicated voltage regulator may be provided for uncore circuitry of a processor, which would allow the uncore to run at a different voltage and frequency. For a compute centric workload, the uncore can be run at a lower voltage and frequency, resulting in applying power savings toward higher core frequencies at a socket level. For memory and IO intensive workloads, the uncore can be run at a higher voltage and frequency, while the cores can run at lower voltages/frequencies, compensating for higher power in the uncore.

[0012] In some embodiments, ACPI tables may be extended to include information regarding these individual integrated voltage regulators to enable per core P-state control. For example, a 4-bit field may be used to pass P-state information and map it to control voltage logic for each regulator. Thus using embodiments of the present invention, each core may be controlled to operate at a different frequency and/or voltage for an asymmetric workload. As one example, one or a few of multiple cores can be controlled to operate at higher frequencies and/or voltages while the remaining cores are controlled to operate at lower voltage/frequency combinations to thus stay within a given thermal design power (TDP) envelope. In this way, deterministic and optimal performance capability selection can be realized for given workloads.

[0013] For example, cores that seek a higher performance level to process data in a first manner can operate at a higher voltage/frequency (such cores may execute tasks such as data processing usage such as data-duplication services, data analytics, parity computations or so forth), while cores executing, e.g., management tasks, can run at lower voltages/frequencies to provide for an optimal mix for a TDP-constrained environment. Thus rather than opportunistically running all cores at a higher frequency when possible (as with a so-called

turbo mode) given a thermal or TDP budget, embodiments provide for deterministic behavior on an individual core basis.

[0014] Referring now to FIG. 1, shown is a block diagram of a portion of a system in accordance with an embodiment of the present invention. As shown in FIG. 1, system 100 may include various components, including a processor 110 which as shown is a multi-core processor. Processor 110 may be coupled to a power supply 150 via an external voltage regulator 160, which may perform a first voltage conversion to provide a primary regulated voltage to processor 110.

[0015] As seen, processor 110 may be a single die processor including multiple cores 120_a-120_n. In addition, each core may be associated with an individual voltage regulator 125_a-125_n. Accordingly, a fully integrated voltage regulator (FIVR) implementation may be provided to thus allow for fine-grained control of voltage and thus power and performance of each individual core.

[0016] Still referring to FIG. 1, additional components may be present within the processor including an input/output interface 132, another interface 134, and an integrated memory controller 136. As seen, each of these components may be powered by another integrated voltage regulator 125_x. In one embodiment, interface 132 may be in accordance with the Intel® Quick Path Interconnect (QPI) protocol, which provides for point-to-point (PtP) links in a cache coherent protocol that includes multiple layers including a physical layer, a link layer and a protocol layer. In turn, interface 134 may be in accordance with a Peripheral Component Interconnect Express (PCIe™) specification, e.g., the PCI Express™ Specification Base Specification version 2.0 (published Jan. 17, 2007). While not shown for ease of illustration, understand that additional components may be present within processor 110 such as uncore logic, a power control unit, and other components such as internal memories, e.g., one or more levels of a cache memory hierarchy and so forth. Furthermore, while shown in the implementation of FIG. 1 with an integrated voltage regulator, embodiments are not so limited.

[0017] Referring now to FIG. 2, shown is a flow diagram of a method in accordance with one embodiment of the present invention. Method 200 may be performed, in one embodiment, by a controller such as an integrated power control unit (PCU) of a processor. However, understand that the scope of the present invention is not limited in this regard and method 200 may be performed by other controllers within a system such as a management engine.

[0018] With reference to FIG. 2, method 200 may begin by receiving a performance state change request in the PCU (block 210). For example, in many implementations this request may be received from the OS or system software. As an example, this request may correspond to a request to change a P-state for one or more cores. That is, in such implementations, the OS may be aware of the per core P-state control provided by embodiments of the present invention. In other embodiments, even when the OS or system software is not aware of this feature, a performance state change request may be received and handled as discussed herein.

[0019] At diamond 220 it may be determined whether an increase in performance is requested. That is, the request may be an identification of a higher performance level (e.g., corresponding to a lower than current P-state such as a request to enter the P0 state from the P1 state). Note also that this determination may also confirm that it is possible to change

P-state from the current state. If so, control passes to block 230. At block 230, a determination may be made as to a selection of one or more cores to increase its voltage independently of at least another core (block 230). As examples of this decision, the PCU may determine to increase voltage and associated frequency based on TDP margin that depends upon various factors such as overall die current, power, temperature, and micro-architectural activities (such as load/store buffers, a thread scheduler or so forth). For example, where a portion of a multi-core processor is determined to be cooler (and operating at lower voltage/frequency), a core within this portion may be selected for increased voltage and frequency.

[0020] When the one or more cores selected for increased voltage are determined, control passes to block 240, where a new voltage and frequency are calculated for the selected core(s). Such calculations may be based at least in part on a TDP specification for the processor, Icc headroom and so forth.

[0021] Still referring to FIG. 2, control passes next to block 250 where a control signal for the new voltage may be sent to the voltage regulator associated with the core or cores. As an example, this control signal may be a digital control signal or it may be an analog signal to thus cause the voltage regulator to initiate a change to a different voltage level. Accordingly, the FIVR associated with the core(s) may be adjusted to thus output an updated voltage to the core. Thus, control passes to block 260, where the core may operate at the selected voltage. Note that because in many embodiments the voltage regulator may be integrated within the processor, this adjustment may occur with reduced latency as compared to an off-chip regulator.

[0022] If instead it is determined at diamond 220 that a decrease in performance is requested, control passes to block 270. At block 270, a determination may be made as to a selection of one or more cores to decrease voltage independently of at least another core (block 270). Such decision may be based on factors such as described above, and may include a determination that movement to a different P-state is permitted.

[0023] When the one or more cores selected for decreased voltage are determined, control passes to block 275, where a new voltage and frequency may be calculated for the selected core(s). Control passes next to block 280 where a control signal for the new voltage may be sent to the voltage regulator associated with the core or cores to cause the FIVR associated with the core(s) to output a decreased voltage to the core. Accordingly, control passes to block 290, where the core may operate at the selected voltage. While shown with this particular implementation in the embodiment of FIG. 2, understand the scope of the present invention is not limited in this regard. For example, the above discussion assumes that the PCU and the cores are part of the same semiconductor die, e.g., of a multicore processor. In other embodiments, the cores may be on independent dies but of the same multichip package. In still further embodiments, cores may be in separate packages but have their voltage/frequency controlled in common, e.g., using coordinated voltage regulators.

[0024] One alternate embodiment is an implementation in which a processor does not include integrated regulators. In such processors, embodiments can still be accommodated to provide per core P-state control. To that end, instead at blocks 250 or 280, control signals for different voltages can be provided, e.g., to the cores directly, where the cores can provide

for voltage adjustments based on the received a voltage. In yet further embodiments, at blocks 250 and 280 the control signals for the changed voltage can be provided off-chip to an external voltage regulator. This control signal may be transmitted on a single pin or multiple pins, where each of the multiple pins is associated with a different voltage level to cause the external voltage regulator to provide one of multiple voltages. Specifically in such implementations, the external voltage regulator may output multiple voltage signals, which can be coupled to the processor and in turn, e.g., to a voltage transmission logic of the processor which can further receive control signals from the power control unit to thus enable selected voltages to be provided to the corresponding cores, as determined by the power control unit.

[0025] In yet other embodiments, for example, in a multi-OS system where a number of cores can be dedicated to one OS and a different number of cores are dedicated to a different OS, each core in one OS domain can be statically set to a fixed (and possibly different) V/F, while the cores in another OS domain can vary V/F dynamically during operation. For example, one OS domain may be dedicated to deterministic operations such as management operations for a system and thus can benefit from fixed V/F control. In contrast, an OS domain in which various user-level applications are executed may have non-deterministic workloads and thus may benefit from dynamic independent V/F control in accordance with an embodiment of the present invention.

[0026] In some embodiments, for dynamic control of core V/F, the PCU can, independently of the OS, monitor micro-architectural activities and determine if one or more core's V/F can be dynamically changed to reduce/increase power, depending on the required load demand.

[0027] Referring now to FIG. 3, shown is a flow diagram of a method in accordance with one embodiment of the present invention. As shown in FIG. 3, method 300 may be executed by a power control unit of a processor. Thus method 300 may be appropriate where an OS is not aware of the per core P-state capabilities provided by an embodiment of the present invention. In still further embodiments, method 300 may be performed in connection with method 200 described above in situations where the OS is aware of the P-state capability, to provide for improved dynamic control of core P-states.

[0028] As seen in FIG. 3, method 300 may begin by monitoring micro-architectural activities of one or more cores (block 310). While the scope of the present invention is not limited in this regard, such activities may include determining a number of instructions executed in a time window, retirements per time window or so forth.

[0029] Responsive to information obtained from the micro-architectural activities, an analysis may be performed by the power control unit. More specifically, at block 320 the power control unit may analyze the activities as well as a load demand of the processor. For example, the load demand may be based on information regarding the number of threads scheduled to the cores and the types of processes for which these threads are scheduled.

[0030] Control then passes to diamond 330, where the power control unit may determine whether dynamic adjustment of at least one of voltage/frequency for one or more cores is appropriate. For example, if the activities and the load demand indicate that an appropriate trade-off between power and performance is occurring, the power control unit may choose not to dynamically adjust any voltage/frequency combination. Accordingly, method 300 may conclude.

[0031] Otherwise, if it is determined to adjust at least one voltage/frequency pair for a given core, control instead passes to block 340. There, a new voltage and frequency pair may be calculated for the selected core(s).

[0032] Still referring to FIG. 3, control passes next to block 350 where a control signal for the new voltage can be sent to the voltage regulator associated with the core or cores to be updated with a new voltage. In this way, the FIVR associated with the core(s) may be adjusted to thus output an updated voltage to the core. Thus, control passes to block 360, where the core may operate at the selected voltage. While shown with this particular implementation in the embodiment of FIG. 3, understand the scope of the present invention is not limited in this regard.

[0033] For example, in other embodiments not only can the V/F of one or more core(s) dynamically change, but also the uncore frequency and voltage can change to support the required core V/F demand. The uncore frequency is not visible to an OS, but can contribute to the overall die power savings. The uncore power savings can be applied toward core power that would result in increased core performance. Similarly, the core power savings can be applied to increased uncore voltage/frequency to accommodate workloads that may require higher uncore frequency. In some implementations, this dynamic uncore change can be performed using method 300 of FIG. 3.

[0034] Referring now to FIG. 4, shown is a block diagram of a processor in accordance with an embodiment of the present invention. As shown in FIG. 4, processor 400 may be a multicore processor including a plurality of cores 410_a-410_n. In one embodiment, each such core may be configured to operate at multiple voltages and/or frequencies. In addition, each core may be independently controlled to operate at a selected voltage and/or frequency, as discussed above. To this end, each core may be associated with a corresponding voltage regulator 412_a-412_n. The various cores may be coupled via an interconnect 415 to an uncore 420 that includes various components. As seen, the uncore 420 may include a shared cache 430 which may be a last level cache. In addition, the uncore may include an integrated memory controller 440, various interfaces 450 and a power control unit 455.

[0035] In various embodiments, power control unit 455 may be in communication with OS power management code. For example, based on a request received from the OS and information regarding the workloads being processed by the cores, power control unit 455 may determine an appropriate combination of voltage and frequency for operating each of the cores, such as described above with respect to FIG. 2. For example, power control unit 455 may include a table having entries each of which associates a voltage and frequency at which each core is executing. In addition, unit 455 may include a storage having information regarding a TDP or other thermal budget. Based on all of this information, power control unit 455 can dynamically and independently control a frequency and/or voltage to one or more cores to enable deterministic operation and provide for asymmetric workloads to the cores, while remaining within the TDP budget, and further without the need for opportunistic turbo mode operation. Thus responsive to such calculations, power control unit 455 may generate a plurality of control signals to cause the voltage regulators to control the voltage provided to the corresponding cores accordingly.

[0036] In addition, power control unit **455** may independently determine that a change in voltage/frequency is appropriate for one or more cores as discussed above with regard to FIG. 3. In some implementations, the analysis performed by power control unit **455** may be based at least in part on prediction information determined by an activity monitor logic, which may be part of the power control unit. This logic may include a buffer to store information associated with operating cores. The activity monitor may receive incoming data from the various cores regarding their current activity levels. The buffer of the activity monitor may be arranged in various manners. In one embodiment, the buffer may be adapted to store for each core, an indication of a time stamp associated with each power state change event. The activity monitor thus intercepts and time stamps the events in which cores enter and exit given activity states. This monitored data may thus include time stamp data as well as the activity state to indicate, during the interval of storage, how long each core was in a given state, and may be provided to, e.g., a predictor of the power control unit, which may use this information to determine predicted core states for the next interval, which can be used in selection of independent frequency and/or voltage at which to operate the core(s).

[0037] With further reference to FIG. 4, processor **400** may communicate with a system memory **460**, e.g., via a memory bus. In addition, by interfaces **450**, connection can be made to various off-chip components such as peripheral devices, mass storage and so forth. While shown with this particular implementation in the embodiment of FIG. 4, the scope of the present invention is not limited in this regard.

[0038] Referring now to FIG. 5, shown is a block diagram of a processor core in accordance with one embodiment of the present invention. As shown in FIG. 5, processor core **500** may be a multi-stage pipelined out-of-order processor. As shown in FIG. 5, core **500** may operate at various voltages and frequencies as a result of integrated voltage regulator **509**. In various embodiments, this regulator may receive an incoming voltage signal, e.g., from an external voltage regulator and may further receive one or more control signals, e.g., from uncore logic coupled to core **500**.

[0039] As seen in FIG. 5, core **500** includes front end units **510**, which may be used to fetch instructions to be executed and prepare them for use later in the processor. For example, front end units **510** may include a fetch unit **501**, an instruction cache **503**, and an instruction decoder **505**. In some implementations, front end units **510** may further include a trace cache, along with microcode storage as well as a micro-operation storage. Fetch unit **501** may fetch macro-instructions, e.g., from memory or instruction cache **503**, and feed them to instruction decoder **505** to decode them into primitives, i.e., micro-operations for execution by the processor.

[0040] Coupled between front end units **510** and execution units **520** is an out-of-order (OOO) engine **515** that may be used to receive the micro-instructions and prepare them for execution. More specifically OOO engine **515** may include various buffers to re-order micro-instruction flow and allocate various resources needed for execution, as well as to provide renaming of logical registers onto storage locations within various register files such as register file **530** and extended register file **535**. Register file **530** may include separate register files for integer and floating point operations. Extended register file **535** may provide storage for vector-sized units, e.g., 256 or 512 bits per register.

[0041] Various resources may be present in execution units **520**, including, for example, various integer, floating point, and single instruction multiple data (SIMD) logic units, among other specialized hardware. For example, such execution units may include one or more arithmetic logic units (ALUs) **522**, among other such execution units.

[0042] Results from the execution units may be provided to retirement logic, namely a reorder buffer (ROB) **540**. More specifically, ROB **540** may include various arrays and logic to receive information associated with instructions that are executed. This information is then examined by ROB **540** to determine whether the instructions can be validly retired and result data committed to the architectural state of the processor, or whether one or more exceptions occurred that prevent a proper retirement of the instructions. Of course, ROB **540** may handle other operations associated with retirement.

[0043] As shown in FIG. 5, ROB **540** is coupled to a cache **550** which, in one embodiment may be a low level cache (e.g., an L1 cache) although the scope of the present invention is not limited in this regard. Also, execution units **520** can be directly coupled to cache **550**. From cache **550**, data communication may occur with higher level caches, system memory and so forth. While shown with this high level in the embodiment of FIG. 5, understand the scope of the present invention is not limited in this regard. For example, while the implementation of FIG. 5 is with regard to an out-of-order machine such as of a so-called x86 instruction set architecture (ISA), the scope of the present invention is not limited in this regard. That is, other embodiments may be implemented in an in-order processor, a reduced instruction set computing (RISC) processor such as an ARM-based processor, or a processor of another type of ISA that can emulate instructions and operations of a different ISA via an emulation engine and associated logic circuitry.

[0044] Embodiments may be implemented in many different system types. Referring now to FIG. 6, shown is a block diagram of a system in accordance with an embodiment of the present invention. As shown in FIG. 6, multiprocessor system **600** is a point-to-point interconnect system, and includes a first processor **670** and a second processor **680** coupled via a point-to-point interconnect **650**. As shown in FIG. 6, each of processors **670** and **680** may be multicore processors, including first and second processor cores (i.e., processor cores **674a** and **674b** and processor cores **684a** and **684b**), although potentially many more cores may be present in the processors. Each of the cores may operate at independent voltages/frequencies using multiple independent voltage regulators present within the processors (not shown for ease of illustration in the embodiment of FIG. 6).

[0045] Still referring to FIG. 6, first processor **670** further includes a memory controller hub (MCH) **672** and point-to-point (P-P) interfaces **676** and **678**. Similarly, second processor **680** includes a MCH **682** and P-P interfaces **686** and **688**. As shown in FIG. 6, MCH's **672** and **682** couple the processors to respective memories, namely a memory **632** and a memory **634**, which may be portions of system memory (e.g., DRAM) locally attached to the respective processors. First processor **670** and second processor **680** may be coupled to a chipset **690** via P-P interconnects **652** and **654**, respectively. As shown in FIG. 6, chipset **690** includes P-P interfaces **694** and **698**.

[0046] Furthermore, chipset **690** includes an interface **692** to couple chipset **690** with a high performance graphics engine **638**, by a P-P interconnect **639**. In addition chipset **690**

may include an interface 695, which may be a storage controller to interface with a storage 619. In turn, chipset 690 may be coupled to a first bus 616 via an interface 696. As shown in FIG. 6, various input/output (I/O) devices 614 may be coupled to first bus 616, along with a bus bridge 618 which couples first bus 616 to a second bus 620. Various devices may be coupled to second bus 620 including, for example, a keyboard/mouse 622, communication devices 626 and a data storage unit 628 such as a disk drive or other mass storage device which may include code 630, in one embodiment. Further, an audio I/O 624 may be coupled to second bus 620. Embodiments can be incorporated into other types of systems including mobile devices such as a smart cellular telephone, tablet computer, netbook, or so forth.

[0047] Embodiments may be implemented in code and may be stored on a storage medium having stored thereon instructions which can be used to program a system to perform the instructions. The storage medium may include, but is not limited to, any type of non-transitory storage medium such as disk including floppy disks, optical disks, solid state drives (SSDs), compact disk read-only memories (CD-ROMs), compact disk rewritables (CD-RWs), and magneto-optical disks, semiconductor devices such as read-only memories (ROMs), random access memories (RAMs) such as dynamic random access memories (DRAMs), static random access memories (SRAMs), erasable programmable read-only memories (EPROMs), flash memories, electrically erasable programmable read-only memories (EEPROMs), magnetic or optical cards, or any other type of media suitable for storing electronic instructions.

[0048] While the present invention has been described with respect to a limited number of embodiments, those skilled in the art will appreciate numerous modifications and variations therefrom. It is intended that the appended claims cover all such modifications and variations as fall within the true spirit and scope of this present invention.

What is claimed is:

1. An apparatus comprising:
 - a processor including a plurality of cores and a control logic to control provision of a voltage/frequency to a first core of the plurality of cores independently of provision of a voltage/frequency to at least a second core of the plurality of cores.
2. The apparatus of claim 1, further comprising a plurality of voltage regulators each associated with one of the plurality of cores.
3. The apparatus claim 2, wherein the control logic is to provide a control signal to each of the plurality of voltage regulators to enable the corresponding voltage regulator to provide an independent voltage to the corresponding core.
4. The apparatus of claim 3, wherein the first core is of a first processor and the second core is of a second processor, and each of the first and second processors further includes at least one integrated voltage regulator, the at least one integrated voltage regulator of the first and second processors to be controlled in common.
5. The apparatus of claim 3, wherein the processor comprises a multi-core processor formed on a single semiconductor die further including the plurality of voltage regulators.
6. The apparatus of claim 5, further comprising a first voltage regulator coupled to the multi-core processor to provide a first regulated voltage to the plurality of voltage regu-

lators, and wherein the plurality of voltage regulators are to each provide an independent voltage to at least one of the plurality of cores.

7. The apparatus of claim 1, wherein the control logic includes a power control unit of an uncore portion of the processor.

8. The apparatus of claim 7, wherein the power control unit is to receive a performance state change request from an operating system (OS) and to select at least one of the plurality of cores to update a voltage/frequency provided thereto.

9. The apparatus of claim 7, wherein the power control unit includes an activity monitor to monitor operation of the plurality of cores and to dynamically select at least one of the plurality of cores for provision of an updated voltage/frequency thereto.

10. A method comprising:

receiving a performance state change request in a power control unit of a processor;

selecting at least one core of the processor to adjust a voltage/frequency provided thereto independently of at least one other core of the processor; and

sending a control signal for the adjusted voltage to an integrated voltage regulator associated with the selected core to enable the core to operate at the adjusted voltage.

11. The method of claim 10, further comprising calculating the adjusted voltage for the at least one core based at least in part on a thermal design power (TDP) specification for the processor.

12. The method of claim 11, further comprising selecting the at least one core to adjust the voltage/frequency provided thereto deterministically and not opportunistically.

13. The method of claim 10, further comprising adjusting a first plurality of cores to execute at an increased voltage/frequency independently of a second plurality of cores, so that a thermal design power (TDP) budget for the processor is maintained.

14. The method of claim 10, further comprising receiving the performance state change request from an operating system (OS) or system software, wherein the OS is unaware of an independent voltage control ability of the processor.

15. The method of claim 10, further comprising dynamically controlling an independent voltage/frequency for a first set of cores of the processor, and controlling a second set of cores to receive a fixed voltage/frequency, wherein the first set of cores are associated with a first operating system and the second set of cores are associated with a second operating system.

16. A system comprising:

a processor including a plurality of cores, a plurality of voltage regulators each to independently provide a voltage to at least one of the plurality of cores, and a power control unit to control the plurality of voltage regulators to provide independent voltages to at least some of the plurality of cores, based at least in part on a workload and a thermal design power (TDP) of the processor, the processor formed on a single semiconductor die; and a dynamic random access memory (DRAM) coupled to the processor.

17. The system of claim 16, wherein the power control unit includes an activity monitor to monitor operation of the plurality of cores and to dynamically select at least one of the

plurality of cores for provision of an updated voltage/frequency thereto.

18. The system of claim **16**, wherein the power control unit is to cause dynamic adjustment to a voltage/frequency provided to an uncore logic of the processor, the uncore logic including the power control unit and wherein the voltage and frequency at which the uncore logic operates is not visible to an operating system (OS).

19. The system of claim **16**, wherein the power control unit includes an activity monitor to monitor operation of the plurality of cores and to dynamically select at least one of the plurality of cores for provision of an updated voltage/fre-

quency thereto, and wherein at least one other core is to be provided a fixed voltage/frequency.

20. The system of claim **19**, wherein the power control unit is to select the at least one core to be provided with an increased voltage/frequency based at least in part on a temperature of a region of the processor including the at least one core.

21. The system of claim **19**, wherein the power control unit is to predict a usage of the at least one core in a future time period based on information from the activity monitor.

* * * * *